Multilayer Ceramic Chip Capacitors

C1608X7R1E104M080AA (TDK item description : C1608X7R1E104MT****)

Applications		Commercial Grade	
	Δ	Please refer to Part No. CGA3E2X7R1E104M080AA for automotive use.	
Feature	General	General (Up to 50V)	
Series	C1608 [EIA CC0603]		



Size		
Length(L)	1.60mm +/-0.10mm	
Width(W)	0.80mm +/-0.10mm	
Thickness(T)	0.80mm +/-0.10mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern(PA)	0.70 to 1.00mm (Flow Soldering) 0.60 to 0.80mm (Flow Soldering)	Reflow Soldering)
Recommended Land Pattern(PB)	0.80 to 1.00mm (Flow Soldering) 0.60 to 0.80mm (Flow Soldering)	Reflow Soldering)
Recommended Land Pattern(PC)	0.60 to 0.80mm (Flow Soldering) 0.60 to 0.80mm (Flow Soldering)	Reflow Soldering)
Recommended Slit Pattern(SD)		

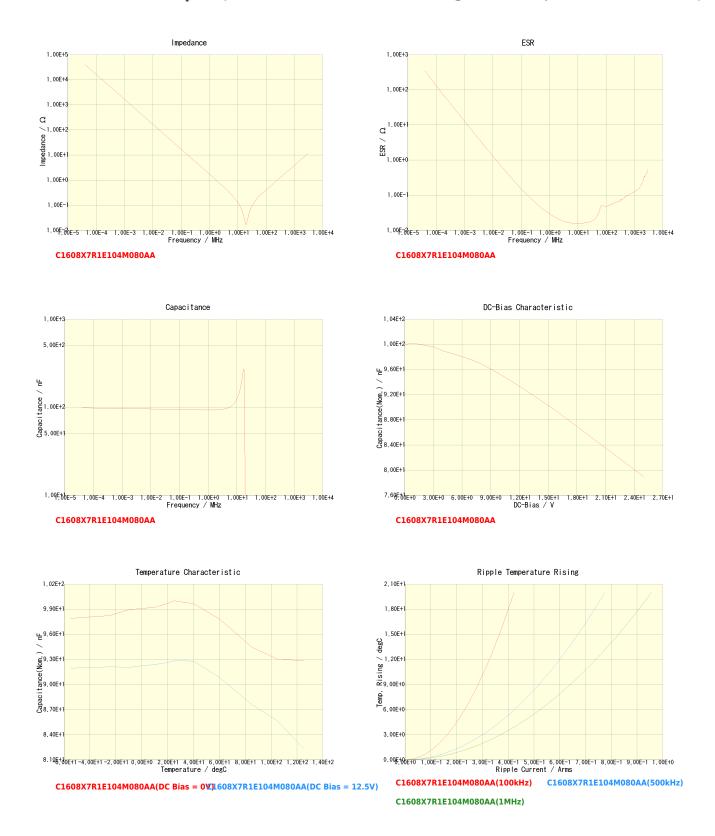
Electrical Characteristics				
Capacitance	100nF +/-20%			
Rated Voltage	25Vdc			
Temperature Characteristic	X7R(+/-15%)			
Dissipation Factor	3% Max.			
Insulation Resistance	5000MΩ Min.			

Other				
Soldering Method	Reflow, Flow			
AEC Q200	No			
Packing	Punched (Paper)Taping [180mm Reel]			
Package Quantity	4000Pcs Min.			

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Characteristic Graphs (This is reference data, and does not guarantee the product's characteristics.)



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